

Surface Preparation Techniques for Adhesive Bonding

Second Edition

Raymond F. Wegman James Van Twisk

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Dedication

To all those engineers and scientists who have dedicated their careers to the advancement of the field of materials and processing for adhesive bonding; and to my wife, Rose, whose encouragement, indulgence, and sacrifice made this book possible.

Preface

The purpose of this handbook is to provide information on processing adherends prior to adhesive bonding. Where sufficient data were available the processes are given in the form of process specifications. Further, where available, data are given to provide potential users with a basis for the selection of the process most suitable for their particular application and facility.

It is known that many of the chemicals used in these processes are hazardous due to their strong oxidizing properties, or may be toxic or hazardous to one's health. It is the user's responsibility to assure that proper safety, handling and disposal procedures are implemented and monitored when any of these methods is employed.

Raymond F. Wegman

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Raymond F. Wegman

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The book is intended for information only. It is known that many of the chemicals used in the processes described are hazardous, due to their strong oxidizing properties, or may be toxic or hazardous to one's health. It is the user's responsibility to assure that proper safety, handling and disposal procedures are implemented and monitored when any of these methods is employed. Expert advice should be obtained at all times when implementation is being considered.

Contents

Pre	eface		xvii		
Acl	knowle	dgments	xviii		
No	Notice				
1	Intro	duction			
	1.1	Adhesion	1		
		1.1.1 Specific Adhesion	1		
		1.1.2 Mechanical Adhesion	2		
	1.2	Bonding	4		
	1.3	Plasma Surface Treatment of Material for Improved Adhesive			
		Bonding	5		
	Refe	erences	7		
2	Alun	ninum and Aluminum Alloys	9		
	2.1	Introduction	9		
	2.2	FPL ETCH	10		
	2.3	Phosphoric Acid Anodize Process	13		
	2.4	P2 Etch Process	16		
	2.5	Chromic Acid Anodize Process	17		
	2.6	Preparation of Aluminum Alloys by the Sol-Gel Process	19		
	2.7	Preparation of Aluminum Alloys by the Optimized			
		FPL Etch (Sulfo-Chrom Etch)	21		
		2.7.1 Apparatus	21		
		2.7.2 Materials	21		
		2.7.3 Processing	23		
		2.7.4 Restrictions	23		
	2.8	Preparation of Aluminum Alloys by the Phosphoric Acid			
		Anodize Process (PAA)	24		
		2.8.1 Apparatus	24		
		2.8.2 Appearance	24		
		2.8.3 Materials	25		
		2.8.4 Processing	25		
		2.8.5 Restrictions	26		
		2.8.6 Anodic Coating Inspection	26		
	2.9	Preparation of Aluminum Alloys by the P2 Etch			
		(Sulfo-Ferric Etch)	27		
		2.9.1 Apparatus	27		

viii Contents

		2.9.2	Materials	28
		2.9.3	Processing	28
		2.9.4	Restrictions	29
	2.10	Prepara	ation of Aluminum Alloys by the Chromic Acid Anodize	
		Metho	d (CAA)	29
		2.10.1	Apparatus	29
			Appearance	30
			Materials	3
		2.10.4	Processing	32
		2.10.5	Restrictions	33
		2.10.6	Specific Controls	33
	2.11		ation of Aluminum Alloys by the AC-130 Sol-Gel	
		Proces		34
		2.11.1	Materials	34
		2.11.2	Facilities Controls	34
			Manufacturing Controls	34
			Storage	34
			Processing	35
			Acceptable Results	35
	Refe	erences	į.	36
3	Titar	ium an	d Titanium Alloys	39
	3.1	Introdu		39
		3.1.1	AC-130 Prebond Surface Treatment	45
	3.2	Prepar	ation of Titanium by the Chromic Acid Anodize Process	46
		3.2.1	Apparatus	47
		3.2.2	Materials	48
			Processing	51
		3.2.4	Restrictions	52
	3.3		ation of Titanium by the Turco 5578 Process	52
		3.3.1	Apparatus	52
		3.3.2	Tank Construction	52
		3.3.3	Materials	52
		3.3.4	Processing	53
		3.3.5	Restrictions	53
	3.4	-10-10-10-10	ation of Titanium by the Liquid Hone/Pasa-Jell 107 Process	54
		3.4.1	Apparatus	54
		3.4.2	Materials	54
		3.4.3	Processing	55
		3.4.4	Restrictions	56
	3.5		ation of Titanium by the Dry Hone/Pasa-Jell 107 Process	56
	3.3	3.5.1	Apparatus	56
		3.5.2	Materials	57
		3.5.3	Processing	57
		3.5.4	Restrictions	58
		3.3.4	RESURCIONS	- 20

Contents

	3.6	Preparation of Titanium by the Alkaline Peroxide Process	58
		3.6.1 Apparatus	58
		3.6.2 Materials	58
		3.6.3 Processing	59
		3.6.4 Restrictions	59
	3.7	Preparation of Titanium by the Stabilized Phosphate	
		Fluoride Process	60
		3.7.1 Apparatus	60
		3.7.2 Materials	60
		3.7.3 Processing	61
		3.7.4 Restrictions	62
	3.8	Preparation of Titanium Alloys by the AC-130 Sol—Gel Process	62
		3.8.1 Materials	62
		3.8.2 Facilities Controls	62
		3.8.3 Manufacturing Controls	62
		3.8.4 Storage	62
		3.8.5 Processing	63
		3.8.6 Acceptable Results	63
	Refe	erences	64
ı	Steel	and Stainless Steel	67
	4.1		67
	4.2	Carbon and Alloy Steels	67
	4.3	Bonding to Oily Steel	69
		4.3.1 Preparation for Bonding to Oily Steel	69
	4.4	Conversion Coating of Steel	70
	4.5	Stainless Steel	70
	4.6	Specialty Stainless Steels	71
	4.7	Preparation of AM355 Stainless Steel by the AC-130	
		Sol-Gel Process	72
		4.7.1 Materials	72
		4.7.2 Facilities Controls	72
		4.7.3 Manufacturing Controls	72
		4.7.4 Storage	73
		4.7.5 Processing	73
		4.7.6 Acceptable Results	74
	4.8	Preparation of Steel by the Phosphoric Acid-Alcohol Process	74
		4.8.1 Apparatus	74
		4.8.2 Materials	74
		4.8.3 Processing	75
		4.8.4 Variations	75
		4.8.5 Restrictions	76
	4.9	Preparation of Steel by the Nitric-Phosphoric Acid Process	76
		4.9.1 Apparatus	76
		4.9.2 Materials	76
		4.9.3 Processing	76

x Contents

	4.10	Prepar	ration of Stainless Steel by the Sulfuric	
		•	Sodium Dichromate Process	77
		4.10.1	Apparatus	77
			2 Materials	77
			3 Processing	78
		4.10.4	1 Restrictions	79
	4.11	Prepar	ration of Stainless Steel by the Sulfuric	
			Sodium Bisulfate Process	79
		4.11.1	Apparatus	79
			2 Materials	79
		4.11.3	3 Processing	80
	Ref	erences		81
5	Cop	er and	Copper Alloys	83
	5.1	Introd	luction	83
	5.2	Prepa	ration of Copper and Copper Alloys by the Ferric	
		Chlor	ide-Nitric Acid Process	84
		5.2.1	Apparatus	84
		5.2.2	Materials	84
		5.2.3	Processing	84
		5.2.4	Restrictions	85
	5.3	Prepa	ration of Copper and Copper Alloys by the Ferric	
		Sulfat	e-Sulfuric Acid/Sodium Dichromate-Sulfuric	
		Acid 1	Process	85
		5.3.1	Apparatus	85
		5.3.2	Material	86
		5.3.3	Processing	86
	5.4		ration of Copper and Copper Alloys by the Black	
			Process	87
		5.4.1	Apparatus	87
		5.4.2	Materials	87
		5.4.3	Processing	88
		5.4.4	Restrictions	89
	5.5	Brass		89
		5.5.1	Introduction	89
		5.5.2	Preparation of Brass by a Mechanical—Chemical	
			Process	89
		5.5.3	Preparation of Brass by the Zinc Oxide,	
			Sulfuric Acid, and Nitric Oxide Method	89
	5.6	Bronz		90
		5.6.1	Introduction	90
		5.6.2	Preparation of Bronze by the Zinc Oxide,	
			Sulfuric Acid, and Nitric Acid Process	90
	Refe	erences		90

Contents xi

6	Magr	ıesium		93
	6.1	Introd	uction	93
	6.2	ASTM	1 D1732, Type A, Grade 2 (ASTM D1732	
			sedes the MIL Specification)	95
		6.2.1	Apparatus	95
		6.2.2	Appearance	96
		6.2.3	Materials	96
		6.2.4	Processing	97
	6.3		1 D1732, Type 1, Class C (ASTM D1732	
			sedes the MIL Specification)	98
		6.3.1	Apparatus	98
		6.3.2	Appearance	99
		6.3.3	Materials	99
		6.3.4	Processing	100
		6.3.5	Restrictions	101
	6.4	Prepai	ration of Magnesium and Magnesium Alloys by the	
		Chron	nic Acid Treatment Processes	101
		6.4.1	Apparatus	101
		6.4.2	Materials	102
		6.4.3	Processing	103
	Refe	erences		103
7	Othe	r Meta	ls	105
	7.1	Introd	uction	105
	7.2	Beryll	lium	105
		7.2.1	Preparation of Beryllium by the Sodium	
			Hydroxide Process	105
		7.2.2	Preparation of Beryllium by the BERYLCOAT	
			"D" Process	106
		7.2.3	Cleaning	106
		7.2.4	Surface Activation Treatment	106
		7.2.5	Passivation	106
		7.2.6	General Processing Recommendations	107
	7.3	Cadm	ium (Cadmium Plating)	107
		7.3.1	Preparation of Cadmium and Cadmium Plating	
			by Abrasive Scouring	107
	7.4	Chron	nium (Chromium Plate)	107
		7.4.1	Preparation of Chromium and Chromium Plating	
			by Abrasive Cleaning	108
		7.4.2	Preparation of Chromium and Chromium	
			Plating by the Hydrochloric Acid Process	108
	7.5	Gold		108
		7.5.1	Preparation of Gold by Abrasive Cleaning	108
		7.5.2	Preparation of Gold and Gold Plate by Abrasive Scouring	108

xii Contents

	7.6	Nickel and Nickel Alloys	108
		7.6.1 Preparation of Nickel by Abrasive Cleaning	103
		7.6.2 Preparation of Nickel by the Nitric Acid Etch Process	10
		7.6.3 Sulfuric-Nitric Acid Pickle	10
	7.7	Nickel Plated Parts	109
		7.7.1 Preparation of Nickel Plated Parts by Abrasive	
		Cleaning	109
		7.7.2 Nickel Alloys	10
		7.7.3 Inconel	10
	7.8	Preparation of Inconel Alloys by the AC-130 Sol-Gel	
		Process	11
		7.8.1 Materials	11
		7.8.2 Facilities Control	11
		7.8.3 Manufacturing Controls	11
		7.8.4 Storage	11
		7.8.5 Processing	11
		7.8.6 Acceptable Results	11
	7.9	Platinum	11
		7.9.1 Preparation of Platinum by Abrasive Cleaning	11
		7.9.2 Preparation of Platinum by Abrasive Scouring	11:
	7.10	Silver	11.
	7.11	Uranium	11:
		7.11.1 Preparation of Uranium by Abrasive Cleaning	11.
		7.11.2 Preparation of Uranium by the Acetic	
		Acid-Hydrochloric Acid Process	11.
		7.11.3 Preparation of Uranium by the Nitric Acid Process	11.
	7.12	Zinc	11.
		7.12.1 Preparation of Zinc by Abrasion Cleaning	11.
		7.12.2 Preparation of Zinc by Acid Etch Processes	11.
		7.12.3 Preparation of Zinc by the Sulfuric	
		Acid/Dichromate Etch Processes	11.
	7.13	Rare Metals	114
	7.14	Metal Matrix Composites	114
	Refe	erences	114
8	Plast	ics	11
	8.1	Introduction	11:
	8.2	Organic Matrix Composites	11:
		8.2.1 Peel Ply	11
		8.2.2 Abrasion	11'
	8.3	Thermoset Materials	113
	8.4	Thermoplastic Materials	113
	8.5	Acetal Copolymer (Celcon)	118

Contents xiii

	8.5.1	Preparation of Acetal Copolymer by the Potassium	
		Dichromate/Sulfuric Acid Etch Process	118
	8.5.2	Preparation of Acetal Copolymer by the	
		Hydrochloric Acid Etch (Nonchromate) Process	119
8.6	Acetal	Homopolymer (Delrin)	119
	8.6.1	Preparation of Acetal Copolymer by the Potassium	
		Dichromate/Sulfuric Acid Process	119
	8.6.2	Preparation of Acetal Copolymer by the DuPont R	
		Three-Step Method	119
8.7	Acrylo	onitrile-Butadiene-Styrene	120
	8.7.1	Preparation of ABS by an Abrasive Process	120
	8.7.2	Preparation of ABS by the Sulfuric Acid/Potassium	
		Dichromate Process	120
8.8	Cellulo	osics	121
8.9	Ethyle	ne-Vinyl Acetate	121
8.10	Fluorin	nated Ethylene-Propylene (Teflon R, FEP)	121
	8.10.1	Preparation of FEP by the Sodium Naphthalene	
		Complex Process (ASTM D2093)	121
8.11	Nylon		121
		Preparation of Nylon by the Abrasive Treatment Process	121
	8.11.2	Preparation of Nylon by the Sulfuric	
		Acid/Potassium Dichromate Process	122
	8.11.3	Preparation of Nylon by the Alternate Abrasive	
		Treatment Process	122
8.12	Phenyl	-Oxide-Based Resins (Noryl Repolaryl Ethers)	122
	8.12.1	New Method	122
	8.12.2	New Method	122
8.13	Polyar	yl Sulfone (Astrel [®])	123
		Preparation of Polyaryl Sulfone by Solvent Washing	123
		Preparation of Polyaryl Sulfone by Abrasive Treatment	123
	8.13.3	Preparation of Polyaryl Sulfone by the Sulfuric	
		Acid/Potassium Dichromate Process	123
8.14		rbonate (Lexan R, Calibre R, and Tuffak R)	123
		Preparation of Polycarbonate by Flame Treatment	123
		Preparation of Polycarbonate by Hot Air Treatment	124
		Preparation of Polycarbonate by Abrasive Treatment	124
8.15	Polyet	•	124
	8.15.1	Preparation of Polyethylene by the Potassium	
		Dichromate/Sulfuric Acid Process	124
	8.15.2	Preparation of Polyethylene by the Flame Treatment	
		Method	124
		Introduction	124
		Newer Methods of Treating Low Density Polyethylene	125
	8.15.5	Preparation of Low Density Polyethylene by the	
		Potassium Dichromate/Sulfuric Acid Process	125

xiv

		8.15.6	Preparation of Low Density Polyethylene by	
			the Bleach-Detergent Process	125
		8.15.7	Preparation of Low Density Polyethylene by	
			the Lead Dioxide-Sulfuric Acid Process	125
		8.15.8	Preparation of Low Density Polyethylene by the	
			Potassium Iodate-Sulfuric Acid Process	125
	8.16	Polymo	ethylmethacrylate (Plexiglas or Lucite)	126
		8.16.1	Preparation of Polymethylmethacrylate by	
			Abrasive Treatment	126
	8.17	Polymo	ethylpentane	126
		8.17.1	Preparation of Polymethylpentane by	
			Abrasive Treatment	126
		8.17.2	Preparation of Polymethylpentane by the	
			Potassium Dichromate/Sulfuric Acid Process	126
		8.17.3	Preparation of Polymethylpentane by the	
			Potassium Permanganate Process	126
	8.18	Polyph	enylene Sulfide (Ryton R)	127
		8.18.1	Preparation of Polyphenylene Sulfide by	
			Abrasive Treatment	127
	8.19	Polypro	opylene	127
		8.19.1	Preparation of Polypropylene by the Potassium	
			Dichromate/Sulfuric Acid Process	127
		8.19.2	Preparation of Polypropylene by the Flame	
			Treatment Method	127
			New Methods for Treating Polypropylene	127
		8.19.4	Preparation of Polypropylene by the	
			Bleach-Detergent Process	128
		8.19.5	Preparation of Polypropylene by the Lead	
			Dioxide—Sulfuric Acid Process	128
	8.20	Polysty		128
			Preparation of Polystyrene by Abrasive Treatment	128
		8.20.2	Preparation of Polystyrene by the Sulfuric	
			Acid/Sodium Dichromate Process	128
	8.21	Polysu		129
		8.21.1	Preparation of Polysulfone by the Sulfuric	
			Acid/Sodium Dichromate Process	129
			Preparation of Polysulfone by the Solvent Wash Process	129
			Preparation of Polysulfone by Abrasive Treatment	129
	Refe	rences		129
ν.	ъ			
,	Rubb			131
	9.1	Introdu		131
	9.2	Neopre		132
		9.2.1	Preparation of Neoprene by Abrasive Treatment	132
		9.2.2	Preparation of Neoprene by the Cyclization Process	132

Contents xv

	9.2.3	Cyclization (Modified Process)	133
	9.2.4	Preparation of Neoprene by the Chlorination Process	133
9.3	Ethyle	ne-Propylene-Diene Terpolymer (EPDM)	133
	9.3.1	Preparation of EDPM by Abrasive Treatment	133
	9.3.2	Preparation of EDPM by the Cyclization Process	133
9.4	Silicor	ne Rubber	134
	9.4.1	Preparation of Silicone Rubber by Solvent Cleaning	134
	9.4.2	Preparation of Silicone Rubber by	
		Soap-and-Water Treatment	134
	9.4.3	Priming	134
9.5	Butyl	Rubber	135
	9.5.1	Preparation of Butyl Rubber by Abrasive Treatment	135
	9.5.2	Preparation of Butyl Rubber by the Cyclization Process	135
	9.5.3	Preparation of Butyl Rubber by the Chlorination	
		Process	135
	9.5.4	Priming	136
9.6	Chlore	butyl Rubber	136
	9.6.1	Preparation of Chlorobutyl Rubber by Abrasive	
		Treatment	136
	9.6.2	Preparation of Chlorobutyl Rubber by the	
		Cyclization Process	136
	9.6.3	Preparation of Chlorobutyl Rubber by the	
		Chlorination Process	137
	9.6.4	Priming	137
9.7		osulfonated Polyethylene (Hypalon R)	137
	9.7.1	Preparation of Chlorosulfonated Rubber by	
		Abrasive Treatment	137
	9.7.2	Priming	137
9.8		Rubber	138
	9.8.1	Preparation of Nitrile Rubber by Abrasive Treatment	138
	9.8.2	Preparation of Nitrile Rubber by the Cyclization Process	138
	9.8.3	Preparation of Nitrile Rubber by the Chlorination	120
	0.0.4	Process	138
0.0	9.8.4	Priming	139
9.9		rethane Elastomers	139
	9.9.1	Preparation of Polyurethane Elastomers by	120
	0.0.2	Abrasive Treatment	139
0.10		Priming	139
9.10		etic Natural Rubber	139
	9.10.1	Preparation of Synthetic Natural Rubber by	1 40
	0.10.3	Abrasive Treatment	140
	9.10.2	Preparation of Synthetic Natural Rubber by the	140
	0.10.2	Cyclization Process	140
	9.10.3	Preparation of Synthetic Natural Rubber by the Chlorination Process	140
		CHIOFHIAHOH PTOCESS	140

xvi Contents

9.11	Styrene-Butadiene Rubber	141
	9.11.1 Preparation of Styrene-Butadiene Rubber by	
	Abrasive Treatment	141
	9.11.2 Preparation of Styrene-Butadiene Rubber by the	
	Cyclization Process	141
	9.11.3 Preparation of Styrene—Butadiene Rubber by the	ar was
	Chlorination Process	141
	9.11.4 Priming	142
9.12	Polybutadiene	142
	9.12.1 Preparation of Polybutadiene by Abrasive Treatment	142
	9.12.2 Preparation of Polybutadiene by the Cyclization Process	142
	9.12.3 Preparation of Polybutadiene by the Chlorination Process	143
	9.12.4 Preparation of Polybutadiene by Solvent Wiping	143
9.13	Fluorosilicone Elastomers	143
	9.13.1 Preparation of Fluorosilicone Elastomers by	
	Solvent Cleaning	143
9.14	Epichlorohydrin Rubbers	143
	9.14.1 Preparation of Epichlorohydrin Elastomers by	
	Solvent Cleaning	143
9.15	Polysulfide Rubber	144
	9.15.1 Preparation of Polysulfide Rubber by Abrasive	
	Treatment	144
	9.15.2 Preparation of Polysulfide Rubber by the	61012
	Chlorination Process	144
9.16	Polypropylene Oxide Rubber	144
	9.16.1 Preparation of Polypropylene Oxide Rubber by	
	Solvent Cleaning	144
9.17	Fluorocarbon Elastomers	144
	9.17.1 Preparation of Fluorocarbon Elastomers by	
5 March 1 (1) (4.04)	the Sodium-Naphthalene Complex Process	144
9.18	Polyacrylate or Polyacrylic Rubber	145
	9.18.1 Preparation of Polyacrylate or Polyacrylic Rubber	
	by Abrasive Treatment	145
Ref	erence	145
Index		147

1 Introduction

1.1 Adhesion

Adhesion is a surface phenomenon, i.e., adhesion is controlled by the condition of the surface of the adherend. The ASTM [1] defines adhesion as "the state in which two surfaces are held together by interfacial forces which consist of valence forces or interlocking actions or both." Adhesion between surfaces which are held together by valence forces is called specific adhesion; this is the same type of force which gives rise to cohesion. Cohesion is defined as the state in which particles of a single substance are held together by primary or secondary forces. As used in the field, cohesion is defined as the state in which the particles of the adhesive (or the adherend) are held together.

Adhesion between surfaces in which the adhesive holds the parts together by interlocking action is known as mechanical adhesion.

Both specific adhesion and mechanical adhesion are important to the understanding of how adhesion is affected by surface preparation. Allen [2] in his discussion of the fundamentals of adhesion concluded by stating "... an adhesive bond achieves its strength from the combination of a variety of sources; (mechanisms)... For these mechanisms, the relative importance and the proper way which they should be combined will vary from one example to another, but none should be excluded without very careful consideration and exploration."

1.1.1 Specific Adhesion

According to the theory relating to specific adhesion, this type of adhesion involves the establishment of some kind of attraction between the atoms and the molecules which make up the adhesive and the adherends. These attractions may involve primary bonding forces, which tend to be quite strong; hydrogen bonding, which yields intermediate strength; and the weaker secondary (Van der Waals) forces.

Primary bonding may be covalent or ionic in nature. Covalent bonding involves the sharing of electron pairs between adjacent atoms. Ionic or electrostatic forces are the type of primary bonds that are found in ionic crystals. Another type of primary bond is the metallic bond which is similar to the covalent bond except that it involves the valence electrons in the metal. This type of bonding is discussed by Verink [3], Wegman and Levi [4] and Salomon [5].